1-1775316-1 ACTIVE

TE Internal #: 1-1775316-1

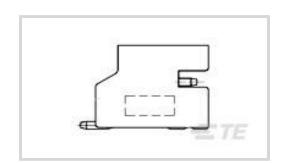
PCB Mount Header, Right Angle, Wire-to-Board, 11 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal,

Natural

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.5 mm Headers



Connector System: Wire-to-Board

Number of Positions: 11

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]
PCB Mount Orientation: Right Angle

All AMP HPI 2.5 mm Headers (78)

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header

Configuration Features

Connector Contact Load Condition	Fully Loaded
Number of Positions	11
Number of Rows	1
PCB Mount Orientation	Right Angle

Electrical Characteristics

Operating Voltage	250 VAC
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Body Features

Primary Product Color	Natural	

Contact Features

Contact Mating Area Length	3.35 mm[.131 in]
Mating Square Post Dimension	.64 mm[.025 in]



PCB Contact Termination Area Plating Material Thickness	2 μm[80 μin]
Contact Layout	Inline
Contact Mating Area Plating Material Thickness	2 μm[80 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Terminations per Post (Max)	3
Termination Post & Tail Length	1 mm[.039 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Mechanical Attachment Mating Alignment Type	Polarization
	Polarization Without
Mating Alignment Type	
Mating Alignment Type Mating Retention	Without
Mating Alignment Type Mating Retention PCB Mount Retention Type	Without Solder Peg
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type	Without Solder Peg Board Mount
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment	Without Solder Peg Board Mount With
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Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch)	Without Solder Peg Board Mount With With Without With
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch) Dimensions	Without Solder Peg Board Mount With With Without With PA 9T GF 2.5 mm[.098 in]
Mating Alignment Type Mating Retention PCB Mount Retention Type Connector Mounting Type Mating Alignment PCB Mount Alignment PCB Mount Retention Housing Features Housing Material Centerline (Pitch) Dimensions Connector Length	Without Solder Peg Board Mount With Without With PA 9T GF 2.5 mm[.098 in] 31.3 mm[1.232 in]



Usage Conditions

Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	700
Packaging Type	Reel

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.



Compatible Parts



Customers Also Bought















KEY A LGR

Documents

Product Drawings

HPI.,2.5MM PITCH,R/A,SMT TYPE,11POS

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-1775316-1_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1775316-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1775316-1_A.3d_stp.zip



English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

HPI Connectors QRG

English

Product Specifications

AMP 2.5MM PITCH HPI WIRE TO BOARD SYSTEM.

English

Application Specification

English

Agency Approvals

UL Report

English